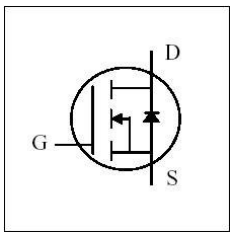
GM9452

N-CHANNEL ENHANCEMENT MODE POWER MOSFET

BV_{DSS}	20V
$R_{DS(ON)}$	50mΩ
I_D	4A

Description

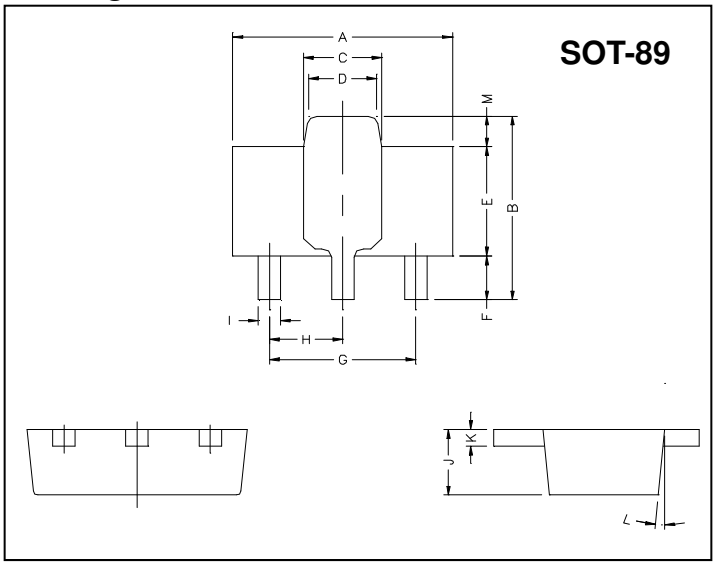
The GM9452 provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

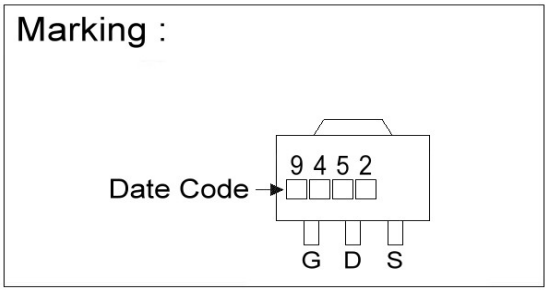


Features

*Simple Drive Requirement
*Low Gate Charge
*Capable of 2.5V Gate Drive

Package Dimensions





REF.	Millimeter		REF.	Millimeter	
	Min.	Max.		Min.	Max.
A	4.4	4.6	G	3.00 REF.	
B	4.05	4.25	H	1.50 REF.	
C	1.50	1.70	I	0.40	0.52
D	1.30	1.50	J	1.40	1.60
E	2.40	2.60	K	0.35	0.41
F	0.89	1.20	L	5° TYP.	
			M	0.70 REF.	

Absolute Maximum Ratings

Parameter	Symbol	Ratings	Unit
Drain-Source Voltage	V_{DS}	20	V
Gate-Source Voltage	V_{GS}	±16	V
Continuous Drain Current[3], V_{GS}@4.5V	I_D @T_A=25℃	4	A
Continuous Drain Current[3], V_{GS}@4.5V	I_D @T_A=70℃	2.5	A
Pulsed Drain Current[1]	I_{DM}	12	A
Total Power Dissipation	P_D @T_A=25℃	1.25	W
Linear Derating Factor		0.01	W/℃
Operating Junction and Storage Temperature Range	Tj, Tstg	-55 ~ +150	℃

Thermal Data

Parameter	Symbol	Value	Unit
Thermal Resistance Junction-ambient[3] Max.	Rthj-a	100	℃/W

Electrical Characteristics(Tj = 25℃ Unless otherwise specified)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Drain-Source Breakdown Voltage	BV_{DSS}	20	-	-	V	V_{GS}=0, I_D=250uA
Breakdown Voltage Temperature Coefficient	$\triangle BV_{DSS}/\triangle Tj$	-	0.03	-	V/℃	Reference to 25℃, I_D=1mA
Gate Threshold Voltage	$V_{GS(th)}$	0.7	-	1.5	V	V_{DS}=V_{GS}, I_D=250uA
Forward Transconductance[2]	g_{fs}	-	10	-	S	V_{DS}=5V, I_D=3A
Gate-Source Leakage Current	I_{GSS}	-	-	±100	nA	V_{GS}= ±16V
Drain-Source Leakage Current(Tj=25℃)	I_{DSS}	-	-	1	uA	V_{DS}=20V, V_{GS}=0
Drain-Source Leakage Current(Tj=70℃)		-	-	25	uA	V_{DS}=16V, V_{GS}=0
Static Drain-Source On-Resistance[2]	$R_{DS(ON)}$	-	-	38	mΩ	V_{GS}=10V, I_D=4A
		-	-	50		V_{GS}=4.5V, I_D=4A
Total Gate Charge[2]	Q_g	-	6	10	nc	I_D=4A V_{DS}=16V V_{GS}=4.5V
Gate-Source Charge	Q_{gs}	-	1	-		
Gate-Drain ("Miller") Change	Q_{gd}	-	2	-		
Turn-on Delay Time[2]	$T_{d(on)}$	-	8	-	ns	V_{DS}=10V I_D=1A V_{GS}=5V R_G=3.3Ω R_D=10Ω
Rise Time	T_r	-	9	-		
Turn-off Delay Time	$T_{d(off)}$	-	13	-		
Fall Time	T_f	-	3	-		
Input Capacitance	C_{iss}	-	360	570	pF	V_{GS}=0V V_{DS}=20V f=1.0MHz
Output Capacitance	C_{oss}	-	80	-		
Reverse Transfer Capacitance	C_{rss}	-	65	-		

Source-Drain Diode

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Forward On Voltage[2]	V_{SD}	-	-	1.3	V	I_S=1A, V_{GS}=0V
Reverse Recovery Time[2]	T_{rr}	-	18	-	ns	I_S=4A, V_{GS}=0V dI/dt=100A/μs
Reverse Recovery Charge	Q_{rr}	-	10	-	nC	

Notes: 1. Pulse width limited by safe operating area.

2. Pulse width≦300us, duty cycle≦2%.

3. Surface mounted on FR4 board, t ≦10sec.

Characteristics Curve

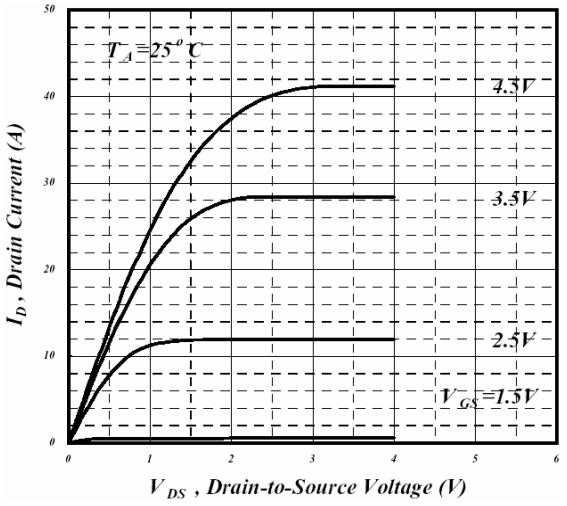


Fig 1. Typical Output Characteristics

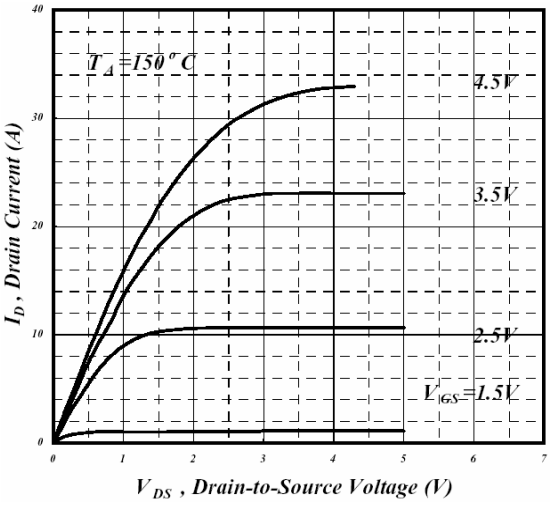


Fig 2. Typical Output Characteristics

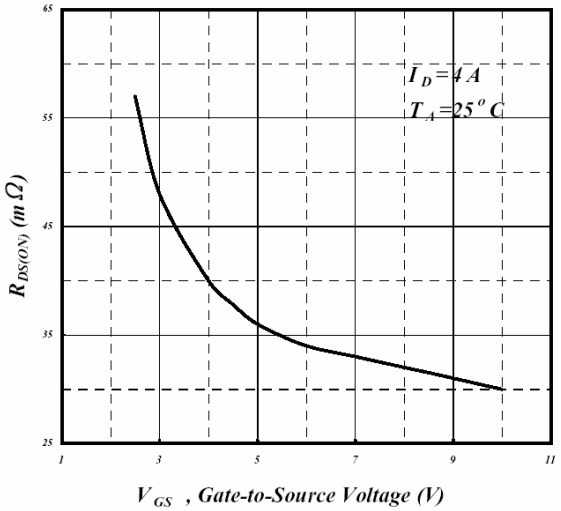


Fig 3. On-Resistance v.s. Gate Voltage

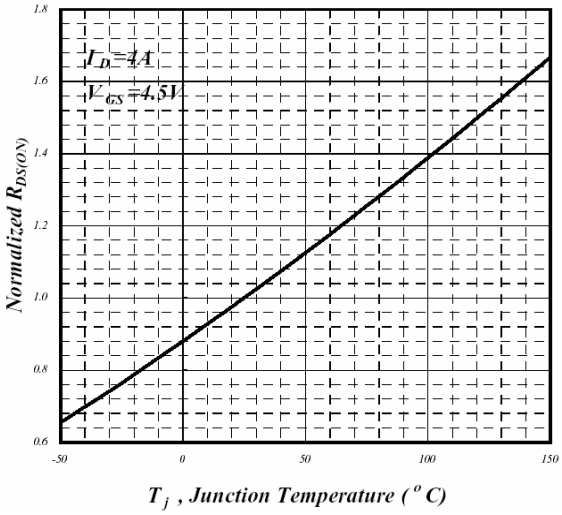


Fig 4. Normalized On-Resistance v.s. Junction Temperature

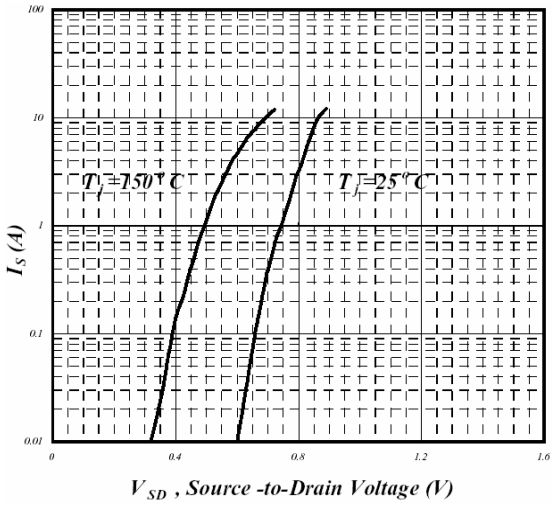


Fig 5. Forward Characteristics of Reverse Diode

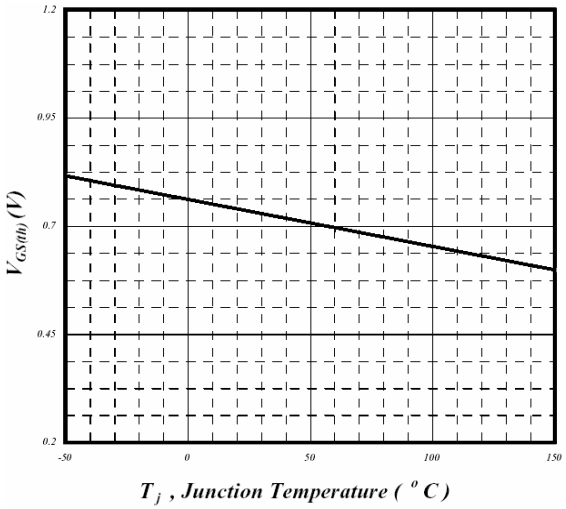


Fig 6. Gate Threshold Voltage v.s. Junction Temperature

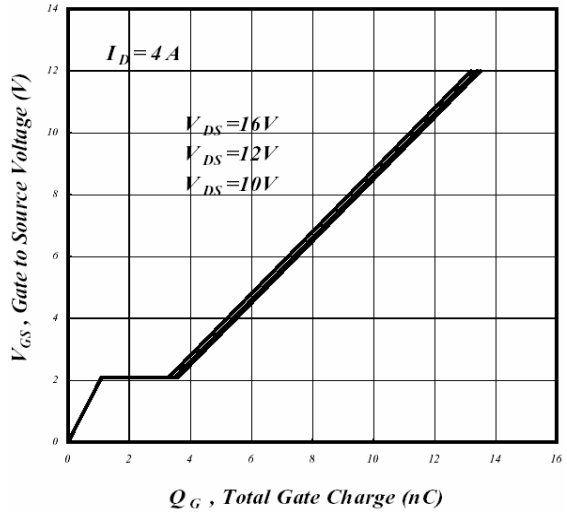


Fig 7. Gate Charge Characteristics

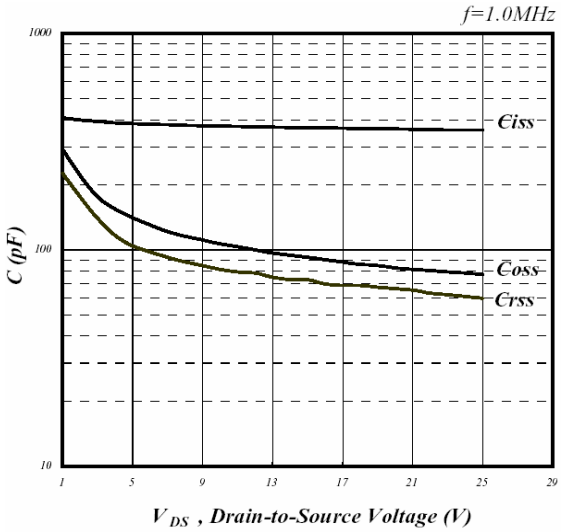


Fig 8. Typical Capacitance Characteristics

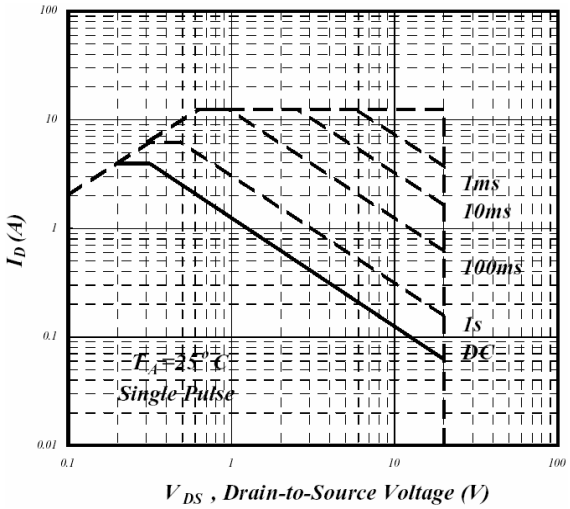


Fig 9. Maximum Safe Operating Area

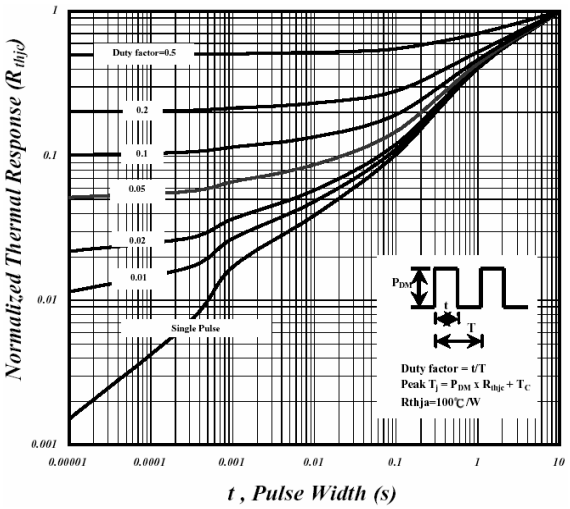


Fig 10. Effective Transient Thermal Impedance

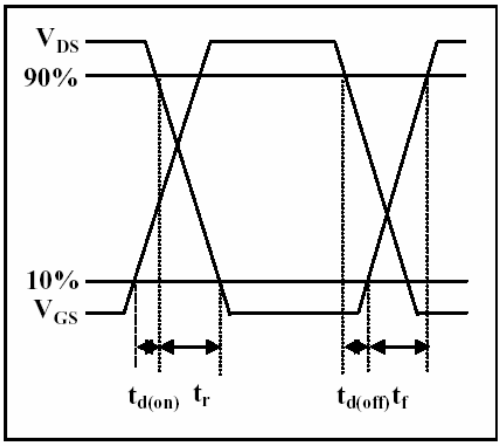


Fig 11. Switching Time Waveform

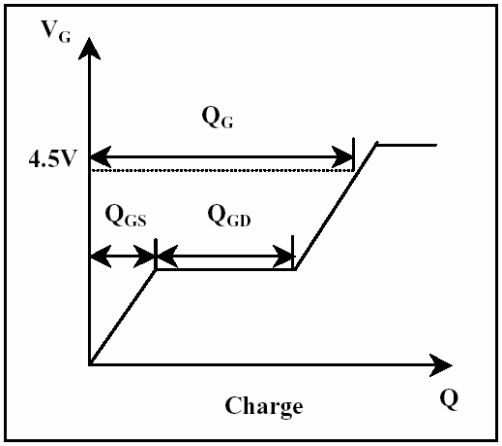


Fig 12. Gate Charge Waveform

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